

# High Voltage Thyristor \ Diode Module

$V_{RRM}$  = 2x2200 V

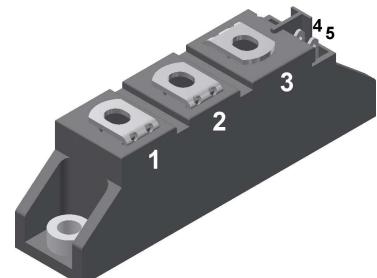
$I_{TAV}$  = 75 A

$V_T$  = 1.21 V

## Phase leg

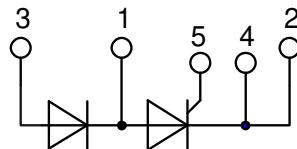
### Part number

**MCNA75PD2200TB**



Backside: isolated

 E72873



### Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al<sub>2</sub>O<sub>3</sub>-ceramic

### Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

### Package: TO-240AA

- Isolation Voltage: 4800 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

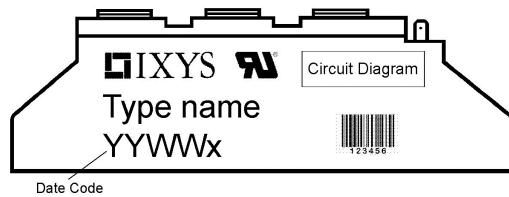
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**Rectifier**

| Symbol         | Definition   | Conditions   | Ratings   |      |              |                       |
|----------------|--|--|---|------|--------------|-----------------------|
|                |  |  | min.  | typ. | max.         |                       |
| $V_{RSM/DSM}$  | max. non-repetitive reverse/forward blocking voltage | $T_{VJ} = 25^\circ C$  |   |      | 2300         | V                     |
| $V_{RRM/DRM}$  | max. repetitive reverse/forward blocking voltage     | $T_{VJ} = 25^\circ C$  |   |      | 2200         | V                     |
| $I_{RD}$       | reverse current, drain current                       | $V_{RD} = 2200 \text{ V}$<br>$V_{RD} = 2200 \text{ V}$   | $T_{VJ} = 25^\circ C$<br>$T_{VJ} = 140^\circ C$ |      | 100<br>10    | $\mu A$<br>mA         |
| $V_T$          | forward voltage drop                                 | $I_T = 75 \text{ A}$   | $T_{VJ} = 25^\circ C$                           |      | 1.24         | V                     |
|                |  | $I_T = 150 \text{ A}$  |   |      | 1.51         | V                     |
|                |  | $I_T = 75 \text{ A}$<br>$I_T = 150 \text{ A}$  | $T_{VJ} = 125^\circ C$                          |      | 1.21<br>1.58 | V                     |
| $I_{TAV}$      | average forward current                              | $T_C = 85^\circ C$   | $T_{VJ} = 140^\circ C$                          |      | 75           | A                     |
| $I_{T(RMS)}$   | RMS forward current                                  | 180° sine  |   |      | 118          | A                     |
| $V_{TO}$       | threshold voltage                                    | $r_T$<br>slope resistance } for power loss calculation only  | $T_{VJ} = 140^\circ C$                          |      | 0.84         | V                     |
|                | slope resistance                                     |  |   |      | 5            | $m\Omega$             |
| $R_{thJC}$     | thermal resistance junction to case                  |  |   |      | 0.38         | K/W                   |
| $R_{thCH}$     | thermal resistance case to heatsink                  |  |   | 0.2  |              | K/W                   |
| $P_{tot}$      | total power dissipation                              |  | $T_C = 25^\circ C$                              |      | 302          | W                     |
| $I_{TSM}$      | max. forward surge current                           | $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$  | $T_{VJ} = 45^\circ C$                           |      | 1.40         | kA                    |
|                |  | $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$   | $V_R = 0 \text{ V}$                             |      | 1.51         | kA                    |
|                |  | $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$  | $T_{VJ} = 140^\circ C$                          |      | 1.19         | kA                    |
|                |  | $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$   | $V_R = 0 \text{ V}$                             |      | 1.29         | kA                    |
| $I^2t$         | value for fusing                                     | $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$  | $T_{VJ} = 45^\circ C$                           |      | 9.80         | $\text{kA}^2\text{s}$ |
|                |  | $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$   | $V_R = 0 \text{ V}$                             |      | 9.49         | $\text{kA}^2\text{s}$ |
|                |  | $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$  | $T_{VJ} = 140^\circ C$                          |      | 7.08         | $\text{kA}^2\text{s}$ |
|                |  | $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$   | $V_R = 0 \text{ V}$                             |      | 6.87         | $\text{kA}^2\text{s}$ |
| $C_J$          | junction capacitance                                 | $V_R = 700 \text{ V}$ $f = 1 \text{ MHz}$  | $T_{VJ} = 25^\circ C$                           | 39   |              | pF                    |
| $P_{GM}$       | max. gate power dissipation                          | $t_p = 30 \mu s$   | $T_C = 140^\circ C$                             |      | 10           | W                     |
|                |  | $t_p = 300 \mu s$  |   |      | 5            | W                     |
| $P_{GAV}$      | average gate power dissipation                       |  |   |      | 0.5          | W                     |
| $(di/dt)_{cr}$ | critical rate of rise of current                     | $T_{VJ} = 140^\circ C; f = 50 \text{ Hz}$ repetitive, $I_T = 225 \text{ A}$  |   |      | 150          | $\text{A}/\mu s$      |
|                |  | $t_p = 200 \mu s; di_G/dt = 0.45 \text{ A}/\mu s;$   |   |      |              |                       |
|                |  | $I_G = 0.45 \text{ A}; V = \frac{2}{3} V_{DRM}$ non-repet., $I_T = 75 \text{ A}$   |   |      | 500          | $\text{A}/\mu s$      |
| $(dv/dt)_{cr}$ | critical rate of rise of voltage                     | $V = \frac{2}{3} V_{DRM}$  | $T_{VJ} = 140^\circ C$                          |      | 1000         | $\text{V}/\mu s$      |
|                |  | $R_{GK} = \infty$ ; method 1 (linear voltage rise)   |   |      |              |                       |
| $V_{GT}$       | gate trigger voltage                                 | $V_D = 6 \text{ V}$  | $T_{VJ} = 25^\circ C$                           |      | 1.4          | V                     |
|                |  |  | $T_{VJ} = -40^\circ C$                          |      | 1.6          | V                     |
| $I_{GT}$       | gate trigger current                                 | $V_D = 6 \text{ V}$  | $T_{VJ} = 25^\circ C$                           |      | 95           | $\mu A$               |
|                |  |  | $T_{VJ} = -40^\circ C$                          |      | 200          | $\mu A$               |
| $V_{GD}$       | gate non-trigger voltage                             | $V_D = \frac{2}{3} V_{DRM}$  | $T_{VJ} = 140^\circ C$                          |      | 0.2          | V                     |
| $I_{GD}$       | gate non-trigger current                             |  |   |      | 10           | $\mu A$               |
| $I_L$          | latching current                                     | $t_p = 10 \mu s$<br>$I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu s$   | $T_{VJ} = 25^\circ C$                           |      | 200          | $\mu A$               |
| $I_H$          | holding current                                      | $V_D = 6 \text{ V}$ $R_{GK} = \infty$  | $T_{VJ} = 25^\circ C$                           |      | 200          | $\mu A$               |
| $t_{gd}$       | gate controlled delay time                           | $V_D = \frac{1}{2} V_{DRM}$<br>$I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu s$  | $T_{VJ} = 25^\circ C$                           |      | 2            | $\mu s$               |
| $t_q$          | turn-off time  | $V_R = 100 \text{ V}; I_T = 75 \text{ A}; V = \frac{2}{3} V_{DRM}$ $T_{VJ} = 125^\circ C$<br>$di/dt = 10 \text{ A}/\mu s$ $dv/dt = 20 \text{ V}/\mu s$ $t_p = 200 \mu s$ |   | 500  |              | $\mu s$               |

| Package TO-240AA |  |                              | Ratings                             |              |      |        |
|------------------|--|------------------------------|-------------------------------------|--------------|------|--------|
| Symbol           | Definition   | Conditions                   | min.                                | typ.         | max. | Unit   |
| $I_{RMS}$        | RMS current  | per terminal                 |                                     |              | 200  | A      |
| $T_{VJ}$         | virtual junction temperature                                 |                              | -40                                 |              | 140  | °C     |
| $T_{op}$         | operation temperature  |                              | -40                                 |              | 125  | °C     |
| $T_{stg}$        | storage temperature  |                              | -40                                 |              | 125  | °C     |
| <b>Weight</b>    |  |                              |                                     | 81           |      | g      |
| $M_D$            | mounting torque  |                              | 2.5                                 |              | 4    | Nm     |
| $M_T$            | terminal torque  |                              | 2.5                                 |              | 4    | Nm     |
| $d_{Spp/App}$    | creepage distance on surface / striking distance through air | terminal to terminal         | 13.0                                | 9.7          |      | mm     |
| $d_{Spb/Apb}$    |  | terminal to backside         | 16.0                                | 16.0         |      | mm     |
| $V_{ISOL}$       | isolation voltage  | t = 1 second<br>t = 1 minute | 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA | 4800<br>4000 |      | V<br>V |



#### Part description

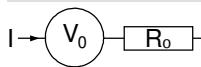
M = Module  
C = Thyristor (SCR)  
N = High Voltage Thyristor  
A = ( $\geq$  2000V)  
75 = Current Rating [A]  
PD = Phase leg  
2200 = Reverse Voltage [V]  
TB = TO-240AA-1B

| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | MCNA75PD2200TB  | MCNA75PD2200TB     | Box           | 36       | 520482   |

#### Equivalent Circuits for Simulation

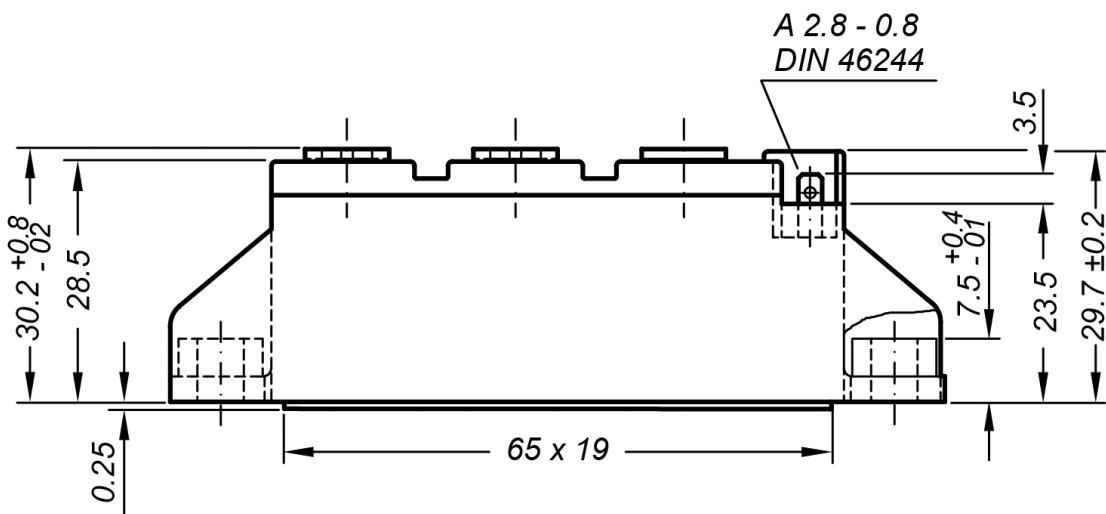
\* on die level

$T_{VJ} = 140^\circ\text{C}$

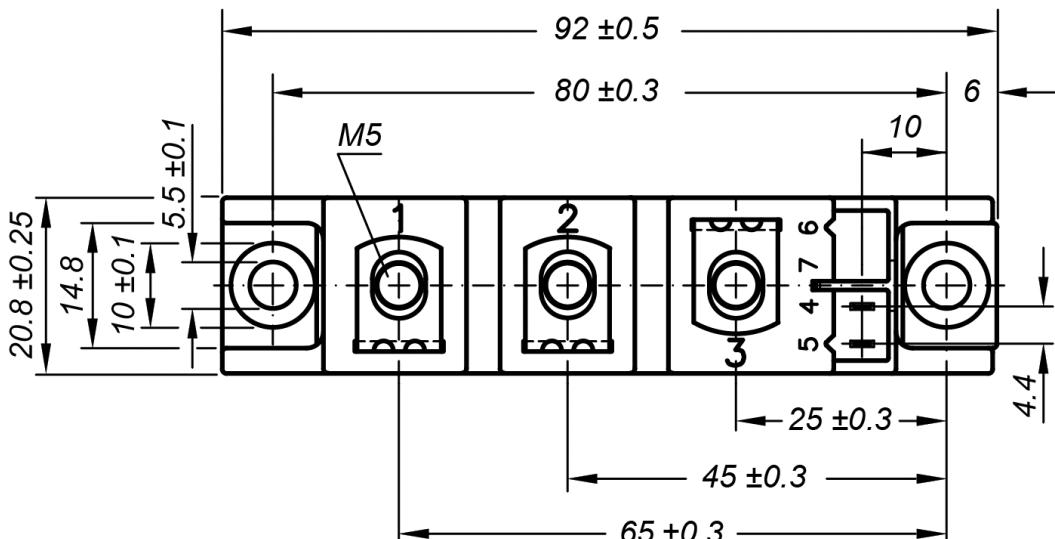


Thyristor

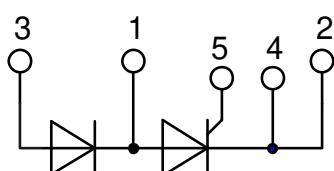
$V_{0\max}$  threshold voltage 0.84 V  
 $R_{0\max}$  slope resistance \* 3.7 mΩ

**Outlines TO-240AA**


General tolerance: DIN ISO 2768 class „c“


**Optional accessories for modules**

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red  
Type ZY 200L (L = Left for pin pair 4/5) UL 758, style 3751



## Thyristor

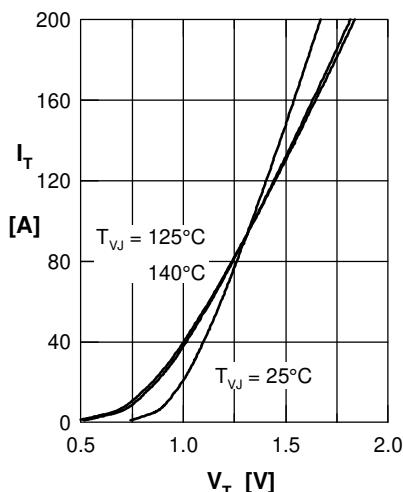


Fig. 1 Forward characteristics

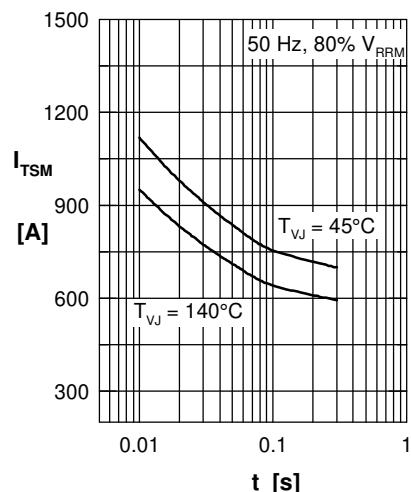


Fig. 2 Surge overload current  
 $I_{TSM}$ : crest value,  $t$ : duration

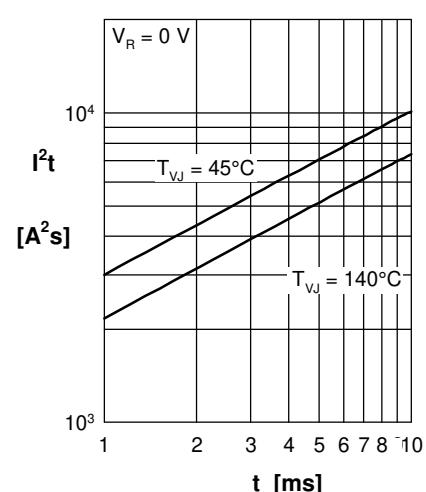


Fig. 3  $I^2t$  versus time (1-10 s)

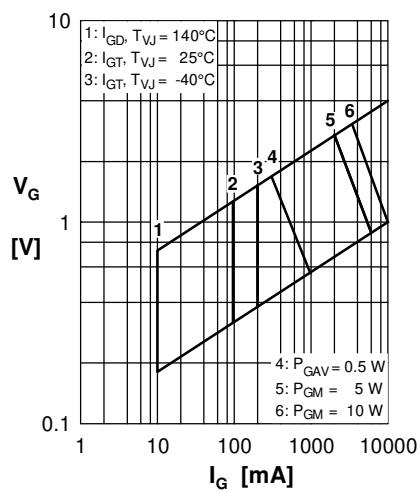


Fig. 4 Gate voltage & gate current

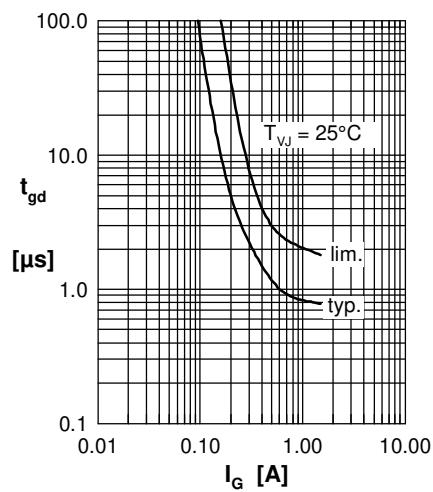


Fig. 5 Gate controlled delay time  $t_{gd}$

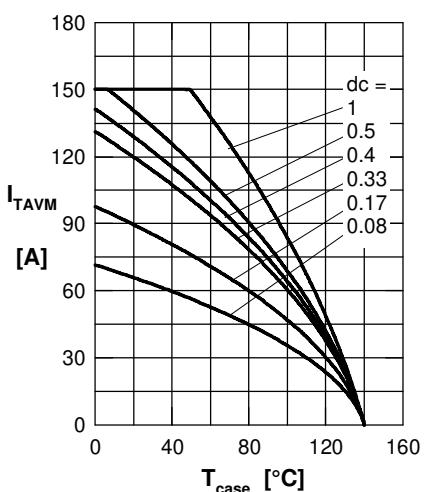


Fig. 6 Max. forward current at case temperature

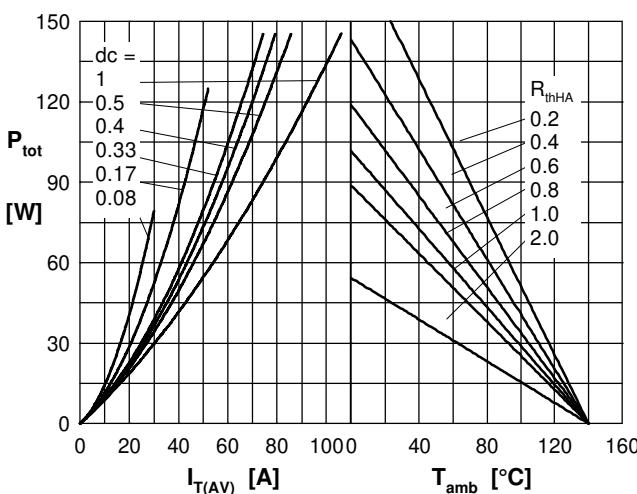


Fig. 7a Power dissipation versus direct output current  
Fig. 7b and ambient temperature

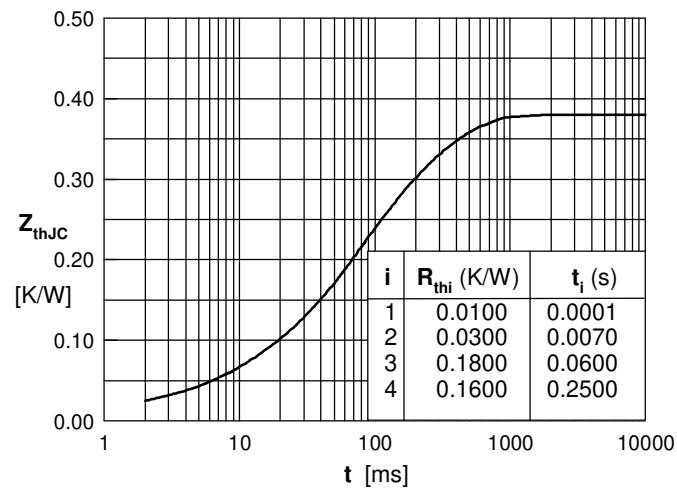


Fig. 8 Transient thermal impedance junction to case



**Стандарт  
Электрон  
Связь**

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